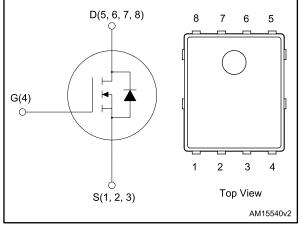
# Automotive-grade N-channel 60 V, 1.2 mΩ typ., 120 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

PowerFLAT™ 5x6

life.augmented

Figure 1: Internal schematic diagram



This is information on a product in full production.

Datasheet - production data

#### **Features**

Order code	V ds	R <sub>DS(on)</sub> max	ΙD
STL225N6F7AG	60 V	1.4 mΩ	120 A

- AEC-Q101 gualified
- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent FoM (figure of merit)
- Low Crss/Ciss ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

### **Applications**

• DC-DC converter for H.E.V. (hybrid electric vehicle)

## Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

#### Table 1: Device summary

		<b>,</b>		
Order code	Marking	Package	Packaging	
STL225N6F7AG	225N6F7	PowerFLAT <sup>™</sup> 5x6	Tape and reel	

#### Contents

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## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
VDS	Drain-source voltage	60	V	
V <sub>GS</sub>	Gate-source voltage	±20	V	
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	120	А	
ID <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	120	А	
I <sub>DM</sub> <sup>(1)(2)</sup>	Drain current (pulsed)	480	А	
Ртот	Total dissipation at $T_C = 25 \ ^{\circ}C$	188	W	
Tj	T <sub>j</sub> Operating junction temperature range		°C	
T <sub>stg</sub>	-55 to 175 Storage temperature range			

#### Notes:

<sup>(1)</sup>This value is limited by package.

 $^{(2)}\mbox{Pulse}$  width limited by safe operating area

	Table 3: Thermal data			
Symbol	Parameter	Value	Unit	
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb	31.3	°C/W	
R <sub>thj-case</sub>	Thermal resistance junction-case	0.8	°C/W	

#### Notes:

 $^{(1)}\!When$  mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.



## 2 Electrical characteristics

(T<sub>c</sub> = 25 °C unless otherwise specified)

Table 4: On /off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, \text{ V}_{GS} = 0 \text{ V}$	60			V
IDSS	Zero gate voltage drain current	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 60 V			1	μA
Igss	Gate-body leakage current	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	2		4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 60 \text{ A}$		1.2	1.4	mΩ

## Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	6500	-	pF
Coss	Output capacitance	V <sub>DS</sub> = 25 V, f = 1 MHz,	-	3200	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0 V$		230	-	рF
Qg	Total gate charge	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 120 \text{ A},$	-	98	-	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	38	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior").	-	28	-	nC

#### Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 60 \text{ A},$	-	41	-	ns
tr	Rise time	$R_{G} = 4.7 \Omega, V_{GS} = 10 V$	-	45	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching times"	-	68	-	ns
tŗ	Fall time	and Figure 18: "Switching time waveform").	-	35	-	ns



#### Electrical characteristics

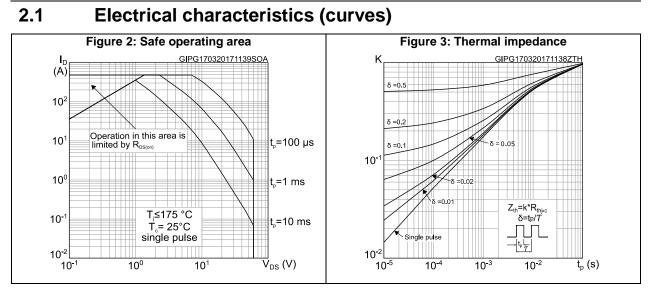
	Table 7: Source-drain diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	I <sub>SD</sub> = 60 A, V <sub>GS</sub> = 0 V	-		1.2	V
trr	Reverse recovery time	I <sub>D</sub> = 60 A, di/dt = 100 A/µs	-	69		ns
Qrr	Reverse recovery charge			103		nC
Irrm	Reverse recovery current	inductive load switching and diode recovery times").	-	3		А

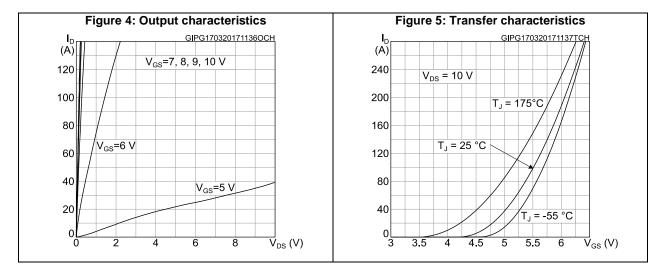
#### Notes:

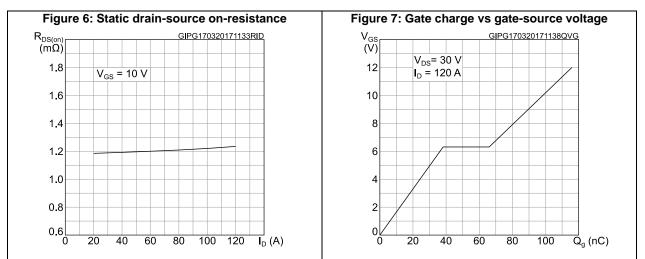
 $^{(1)}\text{Pulsed:}$  pulse duration = 300 µs, duty cycle 1.5%



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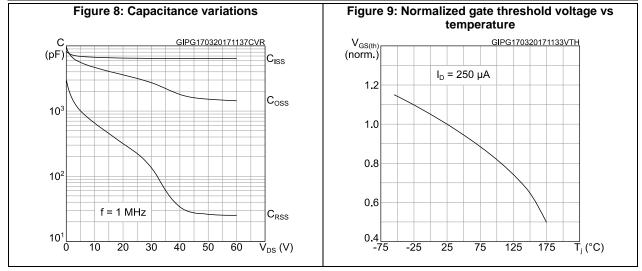


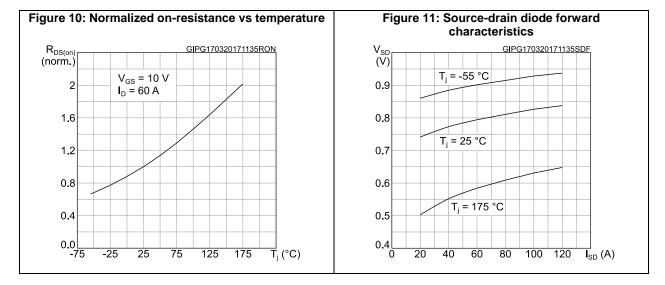


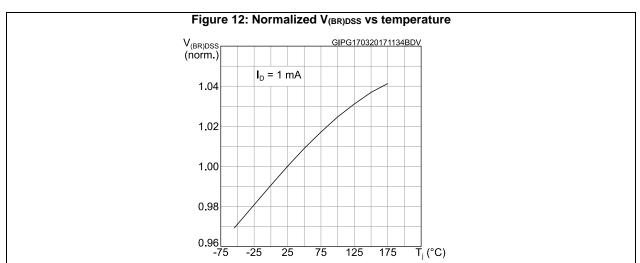




#### **Electrical characteristics**



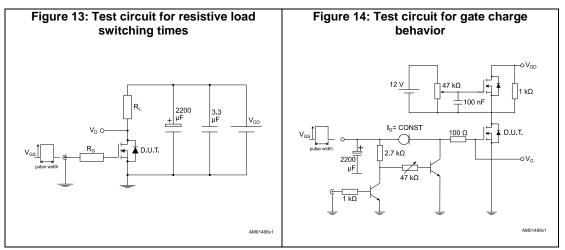


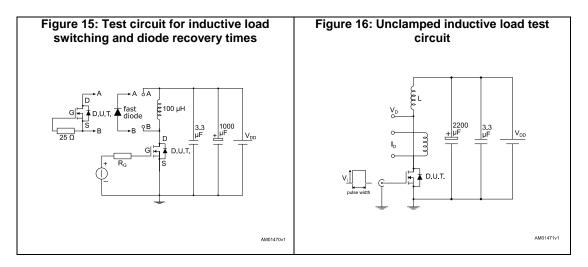


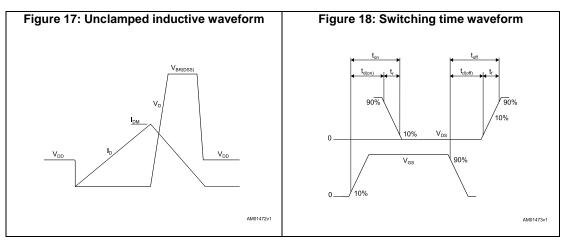
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## 3 Test circuits







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## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

## 4.1 PowerFLAT 5x6 package mechanical data

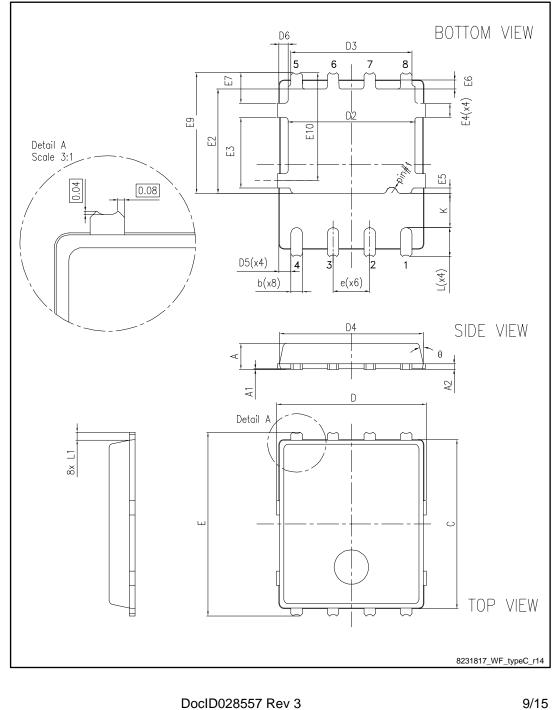


Figure 19: PowerFLAT™ 5x6 WF type C package outline



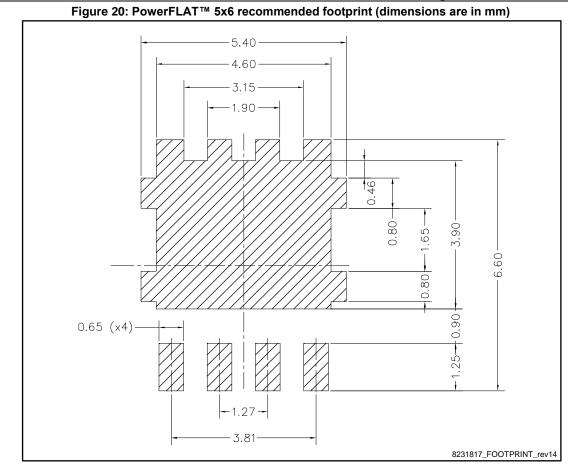
#### Package mechanical data

#### STL225N6F7AG

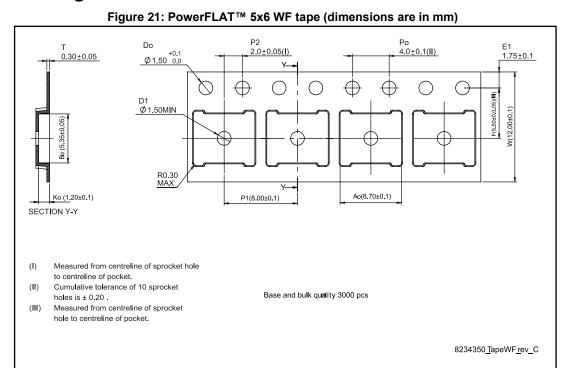
Table 8: PowerFLAT™ 5x6 WF type C mechanical data				
Dim		mm		
Dim.	Min.	Тур.	Max.	
A	0.80		1.00	
A1	0.02		0.05	
A2		0.25		
b	0.30		0.50	
С	5.80	6.00	6.10	
D	5.00	5.20	5.40	
D2	4.15		4.45	
D3	4.05	4.20	4.35	
D4	4.80	5.00	5.10	
D5	0.25	0.40	0.55	
D6	0.15	0.30	0.45	
е		1.27		
E	6.20	6.40	6.60	
E2	3.50		3.70	
E3	2.35		2.55	
E4	0.40		0.60	
E5	0.08		0.28	
E6	0.20	0.325	0.45	
E7	0.85	1.00	1.15	
E9	4.00	4.20	4.40	
E10	3.55	3.70	3.85	
К	1.05		1.35	
L	0.90	1.00	1.10	
L1	0.175	0.275	0.375	
θ	0°		12°	



Package mechanical data

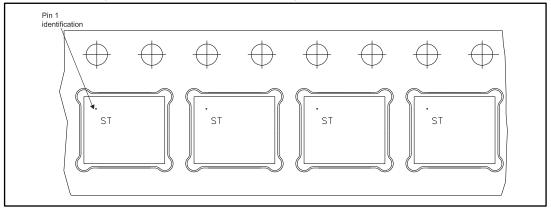


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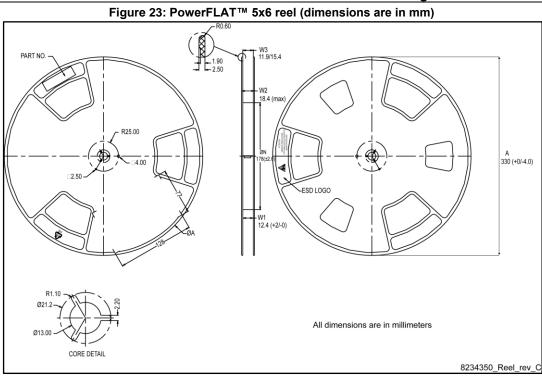
## 4.2 Packing information

Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape











## 5 Revision history

Table 9: Document revision history

Date	Revision	Changes
23-Oct-2015	1	First release.
09-Jun-2016	2	Updated title and features in cover page. Updated Table 2: "Absolute maximum ratings", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode" Minor text changes.
17-Mar-2017	3	Datasheet promoted from preliminary data to production data. Modified title and features on cover page. Modified Table 2: "Absolute maximum ratings". Modified Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode". Added Section 2.1: "Electrical characteristics (curves)". Minor text changes.



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